# MFD METAL FILM LEADED RESISTOR

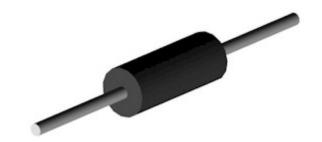


#### **Features**

- Very tight tolerance down to +-0.02%
- Extremely low TCR down to +-5ppm/C
- High precision
- Excellent stability

# **Applications**

- Precision Equipment
- Measurement Equipment



## **■ GENERAL SPECIFICATIONS AND DIMENSIONS**

Model	Power Rating at 70C	Operating Temp. Range	Max. Operating Voltage	Max. Overload Voltage	Resistance Range[Ω]			TCR
					±0.02%	±0.05%	±0.1%	(ppm/C)
0727	1/4W	-55 to +155C	250V	500V		10Ω-500ΚΩ		±5 ±10 ±15 ±25
1040	1/2W		300V	600V		10Ω-1ΜΩ		

# **■ CHARACTERISTICS**

# Values in [ ] mean charge in $\Omega$ after test

Temp. Coefficient of Resistance	As Spec.	Resistance value at room temp. and room temp. +60C		
Short Time Overload	±[0.5%+0.05Ω]	RCWV*2.5 or Max. overload voltage for 5 sec.		
Insulation Resistance		Apply 500VDC for 1 minute, 1000M $\Omega$		
Endurance Data	±[0.5%+0.05Ω]	70±2C, Max. working voltage for 1000hours with 1.5hours "ON" and 0.5hours "OFF"		
Damp Heat with Load	±[0.5%+0.05Ω]	40±2C, 90-95% R.H. Max. working voltage for 1000hours With 1.5hours "ON" and 0.5hours "OFF"		
Soldering Ability	95% min. coverage	245±5C for 3sec.		
Resistance to Soldering Heat	±[0.1%+0.01Ω]	350±10C for 3sec. After test leave for 3hours		
Terminal Strength	Tensile: ≥2.5kg	Tensile strength: for 10sec. Torsional strength: Rotated through 360°, 5 rotations		
Pulse Overload	±[0.5%+0.01Ω]	4 times RCWV for 10000 cycles with 1sec. "ON" and 25 sec. "OFF"		
Temperature Cycle	±[0.5%+0.05Ω]	Low side: -55C/30min., Room temp.: 10 to 15min. High side side: 85C/30min., Room temp.: 10 to 15min.5 cycles		
Resistance No deterioration of coatings to Solvent and markings		Trichroethane for 3 min. with ultrasonic		

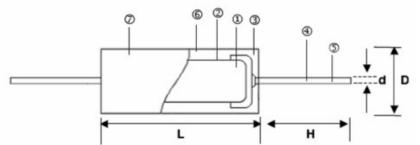
<sup>\*</sup>Reference Standard: MIL-STD-202, JIS-C 5201-1

<sup>\*</sup>Storage Temperature: 25±3C; Humidity < 80%RH



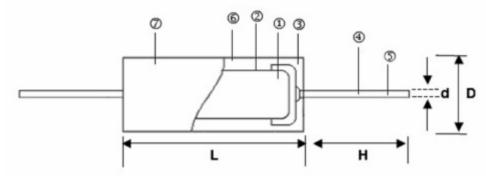
RARA

## **STRUCTURE**



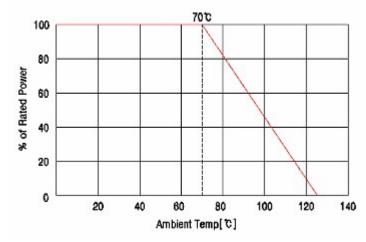
- 1 Ceramic Core(Alumina ceramic)
- 2 Resistor Element(Nickel alloy)
- Terminal(Tinned iron cap)
- 4 Connection
- 5 Lead Wire(Tinned annealed copper wire)
- 6 Molding(Expose)
- 7 Marking(Expose based ink)

#### **DIMENSIONS**



Model	L	D	Н	d	Weight(g) (1000pcs)
MFD0727	7.0±0.3	2.7±0.4	26±3	0.6±0.05	230
MFD1040	10.2±0.3	4.0±0.4	25±3	0.6±0.05	430

#### DERATING CURVE



## **ORDERING PROCEDURE EXAMPLE**

